

TXDVxx12

12 A high voltage Triacs

Features

- On-state current (I_{T(RMS)}): 12 A
- Max. blocking voltage (V_{DRM}/V_{RRM}): 1200 V
- Gate current (I_{GT}): 100 mA
- Commutation @ 10 V/µs: up to 42.5 A/ms
- Noise immunity: 2 kV/µs
- Insulated package:
 - 2,500 V rms (UL recognized: E81734).

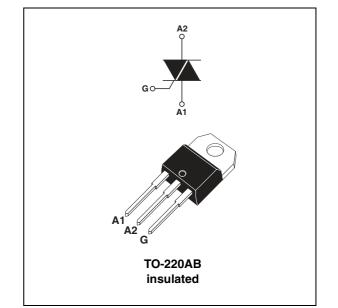
Description

The TXDVxx12 series uses a high performance alternistor technology.

Featuring very high commutation levels and high surge current capability, these devices are well adapted to power control for inductive and resistive loads (motor, transformer...) especially on three-phase power grid. Targeted three-phase applications include heating systems, motor starters, and induction motor speed control (especially for fans).

Table 1. Device summary

Parameter	TXDV812RG TXDV1212RG			
Blocking voltage V _{DRM} /V _{RRM}	800 V	1200 V		
On-state current I _{T(RMS)}	12 A			
Gate current IGT	100 mA			



1 Characteristics

Symbol	Parameter	Value	Unit			
I _{T(RMS)}	On-state rms current (180° conduction angle) $T_c = 90$ °C			12	Α	
V _{DRM}	Repetitive peak off-state voltage	TXDV812	T - 125 °C	800	V	
V _{RRM}	nepetitive peak off-state voltage	TXDV1212	— T _j = 125 °C	1200		
				170		
I _{TSM}	Non repetitive surge peak on-state current	t _p = 8.3 ms	T _j = 25 °C	125	А	
		t _p = 10 ms		120		
l ² t	I ² t value for fusing	t _p = 10 ms	ł	72	A ² s	
dl/dt	Critical rate of rise of on-state current $I_G = 500 \text{ mA}$ $dI_G/dt = 1 \text{ A/}\mu\text{s}$	E = 50 Hz		100	A/µs	
T _{stg} T _j	Storage junction temperature range Operating junction temperature range			- 40 to + 150 - 40 to + 125	°C	
V _{INS(RMS)} ⁽¹⁾	Insulation rms voltage			2500	V	

Table 2. Absolute maximum ratings (limiting values)

1. A1, A2, gate terminals to case for 1 minute

Table 3. Electrical characteristics ($T_j = 25 \text{ °C}$, unless otherwise specified)

Symbol	Test conditions	Quadrant	Quadrant		Value			
Symbol	Test conditions	Quadrant		TXDV812	TXDV1212			
I _{GT}	V _D = 12 V DC, R _I = 33 Ω	1-11-111	MAX.	1(00	mA		
V _{GT}	$v_{\rm D} = 12 \ v \ {\rm DO}, \ {\rm n_{\rm L}} = 33 \ {\rm sz}$	1-11-111	MAX.	1	.5	V		
V _{GD}	$V_D = V_{DRM}$ $R_L = 3.3 \text{ k}\Omega$ $T_j = 110^{\circ}$	C I-II-III	MIN.	0	.2	V		
t _{gt}	$V_D = V_{DRM}$ I _G = 500 mA dI _G /dt = 3 A/µs	1-11-111	TYP.	2	.5	μs		
I.	$I_{G} = 1.2 \text{ x } I_{GT}$	1-111	TYP.	100		mA		
ΙL	IG - 1.2 × IGT	II	.		200			
I _H ⁽¹⁾	I _T = 500 mA Gate open		MAX.	100		mA		
dV/dt ⁽¹⁾	Linear slope up to: $V_D = 67\% V_{DRM}$ Gate open $T_j = 125 \text{ °C}$		MIN.	2	2	kV/µs		
(dl/dt)c ⁽¹⁾	$(dV/dt)c = 10 V/\mu s$ $T_j = 110 °$	С	MIN.	42.5	30	A/ms		
V _{TM} ⁽¹⁾	I _{TM} = 17 A t _p = 380 μs		MAX.	1.	95	V		
V _{to} ⁽¹⁾	Threshold voltage		MAX.	MAX. 1.21		V		
R _d ⁽¹⁾	Dynamic resistance		MAX.	4	0	mΩ		
I _{DRM}	$V_{DBM} = V_{RBM}$ $T_j = 25 °C$		MAX		MAX. 0.01		01	mA
I _{RRM}	$v_{\text{DRM}} = v_{\text{RRM}}$ $T_j = 110^{\circ}$	С	WI/1/1.	2	5			

1. For either polarity of electrode A_2 voltage with reference to electrode $\mathsf{A}_1.$



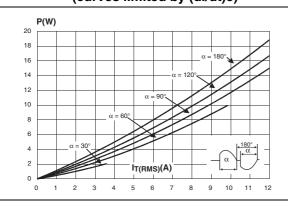
Symbol	Parameter	Value	Unit	
P _{G(AV)}	Average gate power dissipation		1	W
P _{GM}	Peak gate power dissipation	t _p = 20 μs	10	W
I _{GM}	Peak gate current	t _p = 20 μs	4	Α
V _{GM}	Peak positive gate voltage	t _p = 20 μs	16	V

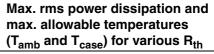
 Table 4.
 Gate characteristics (maximum values)

Table 5.Thermal resistance

Symbol	Parameter	Value	Unit
R _{th(j-a)}	Junction to ambient	60	°C/W
R _{th(j-c)} DC	Junction to case for DC	2.5	°C/W
R _{th(j-c)} AC	Junction to case for 360 °Conduction angle (F = 50 Hz)	1.9	°C/W

Figure 1. Max. rms power dissipation versus Figure 2. on-state rms current (F = 50Hz). (curves limited by (dl/dt)c)





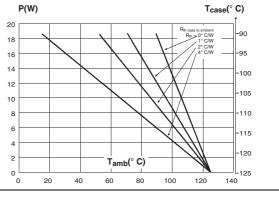


Figure 3. On-state rms current versus case temperature

Relative variation of thermal impedance versus pulse duration

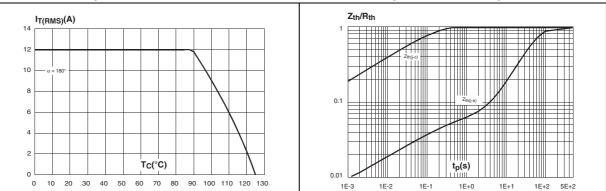
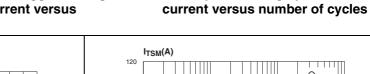


Figure 4.



Figure 5. Relative variation of gate trigger Figure 6. current and holding current versus junction temperature



100

80

60

40

20

0 0

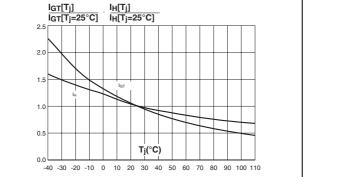
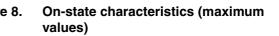


Figure 7. Non-repetitive surge peak on-state Figure 8. current for a sinusoidal pulse and corresponding values of I²t



111

100

1000

Number of cycles

10

Non repetitive surge peak on-state

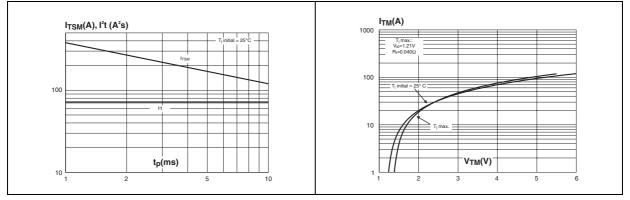
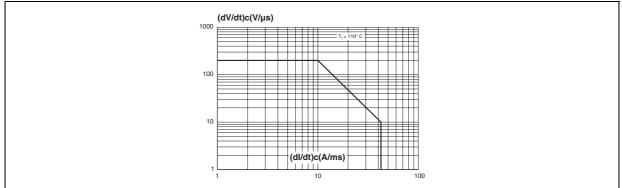


Figure 9. Safe turn-off operating area





2 Package information

- Epoxy meets UL94,V0
- Cooling method: C (by conduction)
- Recommended torque value: 0.4 to 0.6 N·m

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: <u>www.st.com</u>. ECOPACK[®] is an ST trademark.

Table 6. TO-220AB insulated dimensions

					Dimer	nsions		
		Ref.	Mi	illimete	rs		Inches	
			Min.	Тур.	Max.	Min.	Тур.	Max.
		А	15.20		15.90	0.598		0.625
		a1		3.75			0.147	
B		a2	13.00		14.00	0.511		0.551
	b2,	В	10.00		10.40	0.393		0.409
	F C2 M	b1	0.61		0.88	0.024		0.034
A		b2	1.23		1.32	0.048		0.051
I4 I3 -∰-		С	4.40		4.60	0.173		0.181
		c1	0.49		0.70	0.019		0.027
		c2	2.40		2.72	0.094		0.107
a2		е	2.40		2.70	0.094		0.106
		F	6.20		6.60	0.244		0.259
e b1	⊸ c1	ØI	3.75		3.85	0.147		0.151
		14	15.80	16.40	16.80	0.622	0.646	0.661
		L	2.65		2.95	0.104		0.116
		12	1.14		1.70	0.044		0.066
		13	1.14		1.70	0.044		0.066
		М		2.60			0.102	

3 Ordering information

Table 7.Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
TXDV812RG	TXDV812	TO-220AB	2.3 g	50	Tube
TXDV1212RG	TXDV1212	insulated	2.5 y	50	Tube

4 Revision history

Table 8.Document revision history

Date	Revision	Changes
30-Mar-2011	1	Initial release.
13-Jan-2012	2	Updated dl/dt in Table 2, and added V_{to} and R_d in Table 3



Please Read Carefully:

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

UNLESS EXPRESSLY APPROVED IN WRITING BY TWO AUTHORIZED ST REPRESENTATIVES, ST PRODUCTS ARE NOT RECOMMENDED, AUTHORIZED OR WARRANTED FOR USE IN MILITARY, AIR CRAFT, SPACE, LIFE SAVING, OR LIFE SUSTAINING APPLICATIONS, NOR IN PRODUCTS OR SYSTEMS WHERE FAILURE OR MALFUNCTION MAY RESULT IN PERSONAL INJURY, DEATH, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE. ST PRODUCTS WHICH ARE NOT SPECIFIED AS "AUTOMOTIVE GRADE" MAY ONLY BE USED IN AUTOMOTIVE APPLICATIONS AT USER'S OWN RISK.

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries.

Information in this document supersedes and replaces all information previously supplied.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2012 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan -Malaysia - Malta - Morocco - Philippines - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

www.st.com



Doc ID 18272 Rev 2